

STTH30R04

Ultrafast recovery diode

Main product characteristics

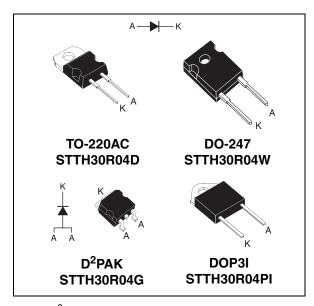
| I _{F(AV)} | 30 A |
|----------------------|--------|
| V _{RRM} | 400 V |
| T _j | 175° C |
| V _F (typ) | 0.97 V |
| t _{rr} | 24 ns |

Features and benefits

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching and conduction losses
- High junction temperature
- Insulated package: DOP3I
 - Electrical insulation = 2500 V_{RMS}
 Package capacitance = 12 pF

Description

The compromise-free, high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability.



Note: D²PAK - 2 anode terminals must be shorted on board.

Order codes

| Part Number | Marking |
|---------------|-------------|
| STTH30R04D | STTH30R04D |
| STTH30R04G | STTH30R04G |
| STTH30R04G-TR | STTH30R04G |
| STTH30R04W | STTH30R04W |
| STTH30R04PI | STTH30R04PI |

Table 1. Absolute ratings (limiting values at 25° C, unless otherwise specified)

| Symbol | F | Parameter | | | |
|---------------------|---|--|-------------------------|-------------|-----|
| V _{RRM} | Repetitive peak reverse voltage | | | 400 | V |
| I _{F(RMS)} | RMS forward current | | | 50 | Α |
| 1 | Average forward current, $\delta = 0.5$ | TO-220AC / DO-247 / D ² PAK | T _c = 120° C | 30 | Α |
| IF(AV) | Average forward current, $\delta = 0.5$ | DOP3I | T _c = 90° C | 30 | ^ |
| I _{FRM} | Repetitive peak forward current | $t_p = 10 \mu s, F = 1 \text{ kHz}$ | | 500 | Α |
| I _{FSM} | Surge non repetitive forward current $t_p = 10 \text{ ms Sinusoidal}$ | | 300 | Α | |
| T _{stg} | Storage temperature range | | | -65 to +175 | ° C |
| T _j | Maximum operating junction tempera | ature range | | -40 to +175 | ° C |

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Characteristics

Table 2. Thermal parameters

| Symbol | Pa | Value | Unit | |
|----------------------|------------------|--|------|-------|
| D | Junction to case | TO-220AC / DO-247 / D ² PAK | 1.15 | °C/W |
| R _{th(j-c)} | Junction to case | DOP3I | 1.9 | C/ VV |

Static electrical characteristics Table 3.

| Symbol | Parameter | Test conditions | | Min | Тур | Max | Unit |
|-------------------------------|-------------------------|-------------------------|-----------------------|-----|------|------|------|
| | | T _j = 25° C | | | | 15 | |
| I _R ⁽¹⁾ | Reverse leakage current | T _j = 100° C | $V_R = V_{RRM}$ | | 3 | 30 | μΑ |
| | | T _j = 125° C | | | 15 | 150 | |
| | | T _j = 25° C | I _F = 15 A | | | 1.26 | |
| | | T _j = 150° C | 1F = 13 A | | 0.8 | 1.0 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 25° C | | | | 1.45 | V |
| | | T _j = 100° C | I _F = 30 A | | | 1.3 | |
| | | T _j = 150° C | | | 0.97 | 1.2 | |

^{1.} Pulse test: t_p = 5 ms, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.9 x $I_{F(AV)}$ + 0.01 x $I_{F}^{2}_{(RMS)}$

$$P = 0.9 \text{ x } I_{F(AV)} + 0.01 \text{ x } I_{F}^{2}_{(RMS)}$$

Table 4. **Dynamic characteristics**

| Symbol | Parameter | Test conditions | Min | Тур | Max | Unit |
|-----------------|--------------------------|---|-----|-----|-----|------|
| | | $I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | 24 | 35 | |
| t _{rr} | Reverse recovery time | $I_F = 1 \text{ A, } dI_F/dt = -15 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | 78 | 100 | ns |
| | | I _F = 1 A, I _R = 1 A, I _{RR} = 0.25 A, T _j = 25° C | | | 50 | |
| I _{RM} | Reverse recovery current | $I_F = 30 \text{ A}, dI_F/dt = -200 \text{ A/µs},$ $V_R = 160 \text{ V}, T_j = 125^{\circ} \text{ C}$ | | 10 | 14 | Α |
| t _{fr} | Forward recovery time | $I_F = 30 \text{ A}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$ | | | 500 | ns |
| V _{FP} | Forward recovery voltage | $I_F = 30 \text{ A}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$ | | 2.9 | | V |

^{2.} Pulse test: t_p = 380 μ s, δ < 2 %

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Figure 1. Conduction losses versus average current

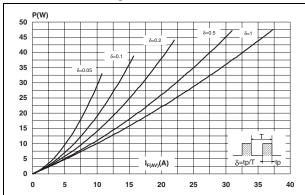


Figure 2. Forward voltage drop versus forward current

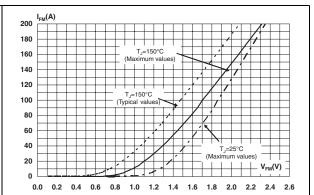
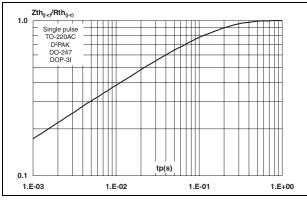


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)



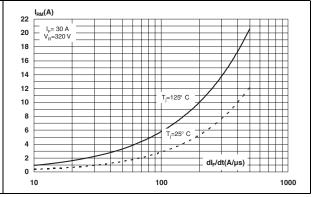


Figure 5. Reverse recovery time versus dl_F/dt (typical values)

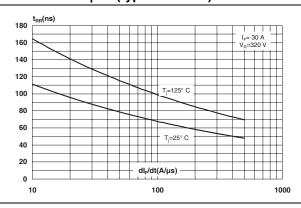
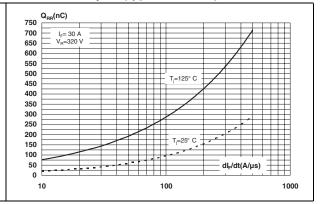


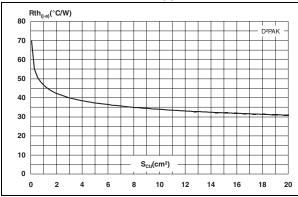
Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



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Figure 7. Thermal resistance junction to ambient versus copper surface under tab (Epoxy printed circuit board FR4, e_{CU} = 35 μ m)

Figure 8. Relative variations of dynamic parameters versus junction temperature



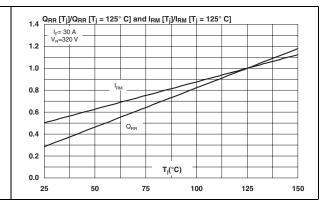
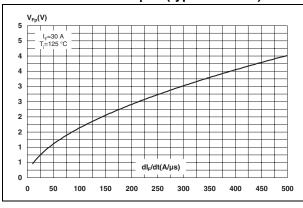


Figure 9. Transient peak forward voltage versus dl_F/dt (typical values)

Figure 10. Forward recovery time versus dl_F/dt (typical values)



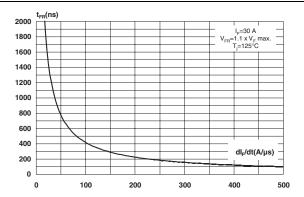
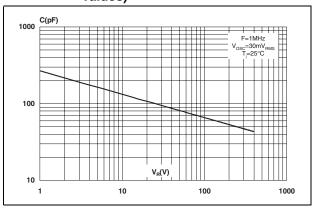


Figure 11. Junction capacitance versus reverse voltage applied (typical values)

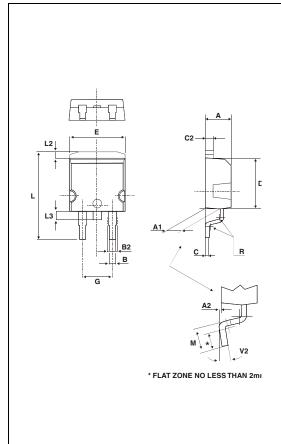


STTH30R04 Package information

2 Package information

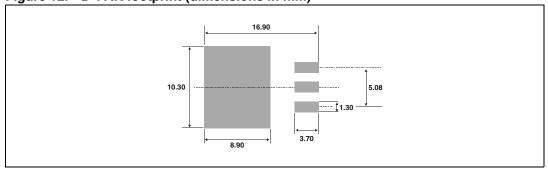
- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 Nm (TO-220FPAC) / 0.55 Nm (TO-220AC, DOP3I)
- Maximum torque value: 1.0 Nm (TO-220FPAC) / 0.70 Nm (TO-220AC, DOP31)

Table 5. D²PAK dimensions



| | Dimensions | | | | |
|------|-------------|-------|-------|--------|--|
| Ref. | Millimeters | | Inc | Inches | |
| | Min. | Max. | Min. | Max. | |
| Α | 4.40 | 4.60 | 0.173 | 0.181 | |
| A1 | 2.49 | 2.69 | 0.098 | 0.106 | |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 | |
| В | 0.70 | 0.93 | 0.027 | 0.037 | |
| B2 | 1.14 | 1.70 | 0.045 | 0.067 | |
| С | 0.45 | 0.60 | 0.017 | 0.024 | |
| C2 | 1.23 | 1.36 | 0.048 | 0.054 | |
| D | 8.95 | 9.35 | 0.352 | 0.368 | |
| Е | 10.00 | 10.40 | 0.393 | 0.409 | |
| G | 4.88 | 5.28 | 0.192 | 0.208 | |
| L | 15.00 | 15.85 | 0.590 | 0.624 | |
| L2 | 1.27 | 1.40 | 0.050 | 0.055 | |
| L3 | 1.40 | 1.75 | 0.055 | 0.069 | |
| М | 2.40 | 3.20 | 0.094 | 0.126 | |
| R | 0.40 | typ. | 0.016 | 6 typ. | |
| V2 | 0° | 8° | 0° | 8° | |

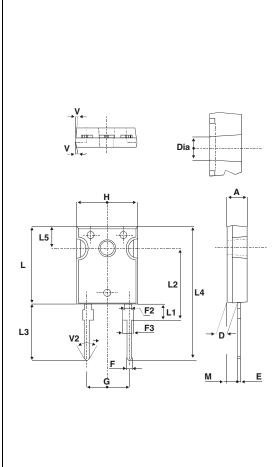
Figure 12. D²PAK footprint (dimensions in mm)



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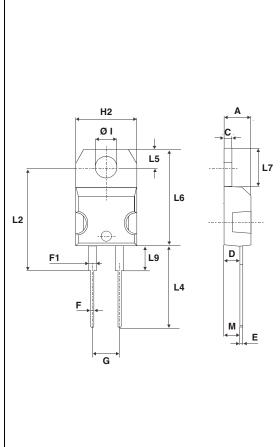
Table 6. DO-247 dimensions



| | Dimensions | | | | | |
|------|------------|-------|-------|-------|--------|-------|
| Ref. | Millimete | | rs | | Inches | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. |
| Α | 4.85 | | 5.15 | 0.191 | | 0.203 |
| D | 2.20 | | 2.60 | 0.086 | | 0.102 |
| Е | 0.40 | | 0.80 | 0.015 | | 0.031 |
| F | 1.00 | | 1.40 | 0.039 | | 0.055 |
| F2 | | 2.00 | | | 0.078 | |
| F3 | 2.00 | | 2.40 | 0.078 | | 0.094 |
| G | | 10.90 | | | 0.429 | |
| Н | 15.45 | | 15.75 | 0.608 | | 0.620 |
| L | 19.85 | | 20.15 | 0.781 | | 0.793 |
| L1 | 3.70 | | 4.30 | 0.145 | | 0.169 |
| L2 | | 18.50 | | | 0.728 | |
| L3 | 14.20 | | 14.80 | 0.559 | | 0.582 |
| L4 | | 34.60 | | | 1.362 | |
| L5 | | 5.50 | | | 0.216 | |
| М | 2.00 | | 3.00 | 0.078 | _ | 0.118 |
| ٧ | | 5° | | | 5° | |
| V2 | | 60° | | | 60° | |
| Dia. | 3.55 | | 3.65 | 0.139 | | 0.143 |

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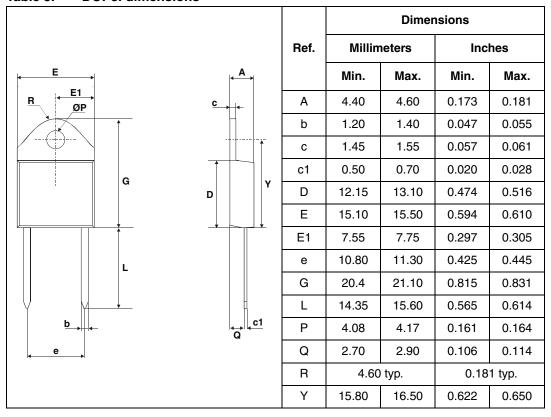
Table 7. TO-220AC dimensions



| | Dimensions | | | | |
|-------|------------|--------|------------|--------|--|
| Ref. | Millim | neters | Inc | hes | |
| | Min. | Max. | Min. | Max. | |
| Α | 4.40 | 4.60 | 0.173 | 0.181 | |
| С | 1.23 | 1.32 | 0.048 | 0.051 | |
| D | 2.40 | 2.72 | 0.094 | 0.107 | |
| Е | 0.49 | 0.70 | 0.019 | 0.027 | |
| F | 0.61 | 0.88 | 0.024 | 0.034 | |
| F1 | 1.14 | 1.70 | 0.044 | 0.066 | |
| G | 4.95 | 5.15 | 0.194 | 0.202 | |
| H2 | 10.00 | 10.40 | 0.393 | 0.409 | |
| L2 | 16.40 | O typ. | 0.645 typ. | | |
| L4 | 13.00 | 14.00 | 0.511 | 0.551 | |
| L5 | 2.65 | 2.95 | 0.104 | 0.116 | |
| L6 | 15.25 | 15.75 | 0.600 | 0.620 | |
| L7 | 6.20 | 6.60 | 0.244 | 0.259 | |
| L9 | 3.50 | 3.93 | 0.137 | 0.154 | |
| М | 2.6 | typ. | 0.10 | 2 typ. | |
| Diam. | 3.75 | 3.85 | 0.147 | 0.151 | |

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Table 8. DOP3I dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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3 Ordering information

| Part Number | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|-------------|--------------------|--------|----------|---------------|
| STTH30R04D | STTH30R04D | TO-220AC | 1.86 g | 50 | Tube |
| STTH30R04G | STTH30R04G | D ² PAK | 1.48 g | 50 | Tube |
| STTH30R04G-TR | STTH30R04G | D ² PAK | 1.48 g | 1000 | Tape and reel |
| STTH30R04W | STTH30R04W | DO-247 | 4.40 g | 30 | Tube |
| STTH30R04PI | STTH30R04PI | DOP3I | 4.46 g | 30 | Tube |

4 Revision history

| Date | Revision | Description of Changes |
|-------------|----------|------------------------|
| 31-Mar-2007 | 1 | First issue. |

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